IPC ASSOCIATION CONN ELECTRONICS INDU	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier Inf	formation													
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*			
nsemi											2024-09-21			
Contact Name		Title - Contact			F	Phone - Contact*				Email - Contact*				
Product-Env-S	Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized Rep	presentative*	Title - Representative			F	Phone - Representative*			Email - Representative*					
Product-Env-S	Stewards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
Req	quester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type
		FDC3535 FET 80V 183.0 mOl		Ohm SSOT6		2024-09-21	РВВ			17.367	mg	Each		
	ring Proccess Informa		Carminal Rasa	Alloy	STD-020 MSL 1	Pating	Dank Droos	see Rody Tam	paratura	May Time at Peak	Tamparat	ura Numb	per of Reflow Cyc	plac
		Terminal Base Alloy J-STD- CU Alloy 1		31D-020 MSL 1	Katilig	Peak Process Body Temper		•				el of Kellow Cyt	lies	
-	te 1 m (Sn) - anneaied	C	LU Alloy	1			200			30	secon	us 3		
omments	4:			20 1-										
	num time at peak temperat	8												
r more infori	mation regarding materia	I composition	piease refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itaability and the Company's remedies for issues that arise regarding information the Supplier provides in this f											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.172	mg	Supplier	Silicon (Si)	7440-21-3		0.172	mg
Die Attach	0.203	mg		Bismaleimide Resin	proprietary data		0.0335	mg
			Supplier	Other Additive Agents	Proprietary Data		0.0071	mg
			Supplier	Silver (Ag)	7440-22-4		0.1624	mg
Lead Frame	8.254		Supplier	Silver (Ag)	7440-22-4		0.022	mg
			Supplier	Zinc (Zn)	7440-66-6		0.01	mg
			Supplier	Iron (Fe)	7439-89-6		0.198	mg
			Supplier	Copper (Cu)	7440-50-8		8.022	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Mold Compound-Black	7.596		Supplier	Zinc borate	1332-07-6		0.2659	mg
			Supplier	Phenol, polymer with 1,4-bis(methoxymethyl)benzene	26834-02-6		0.3038	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.7596	mg
			Supplier	Carbon Black (C)	1333-86-4		0.038	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.2287	mg
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg
Wire Bond - Cu	0.012	mg	Supplier	Copper (Cu)	7440-50-8		0.012	mg